



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	I _D T _A = 25°C
	$77mΩ@V_{GS} = -10V$	-3.5A
-30V	95mΩ@ V _{GS} = -4.5V	-3.0A
	150mΩ@ V _{GS} = -2.5V	-2.4A

Description and Applications

This new generation MOSFET has been designed to minimize the on-state resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

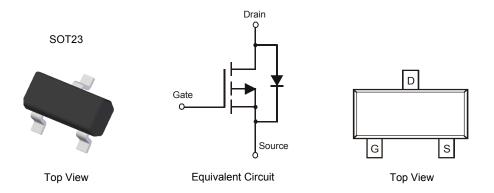
- DC-DC Converters
- Power management functions
- Analog Switch

Features and Benefits

- Low On-Resistance:
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.008 grams (approximate)



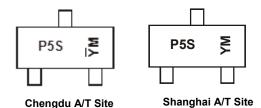
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3130L-7	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



P5S = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test site)

YM = Date Code Marking for CAT (Chengdu Assembly/ Test site)

Y or \overline{Y} = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Date Code Kev

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Year	2008	2009	2010	2011	201	2 20)13	2014	2015	2016	2017	2018
Code	V	W	X	Υ	Z		A	В	С	D	Е	F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V_{DSS}	-30	V	
Gate-Source Voltage		V_{GSS}	±12	V	
Continuous Prain Current (Note 5) // - 45/	Steady State	T _A = 25°C T _A = 70°C	I _D	-3.5 -2.6	А
Continuous Drain Current (Note 5) V _{GS} = -4.5V	t<10s	T _A = 25°C T _A = 70°C	I _D	-4.1 -3.2	А
Maximum Continuous Body Diode Forward Current	t (Note 5)	I _S	-1.6	Α	
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	-20	А	

Thermal Characteristics

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T _A = 25°C	Б	0.7	W
Total Fower Dissipation (Note 5)	T _A = 70°C	P_{D}	0.4	VV
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	р	184	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	115	C/VV
Total Power Dissipation (Note 6)	T _A = 25°C	D-	1.3	W
Total Fower Dissipation (Note 6)	T _A = 70°C	P_D	0.8	VV
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	94	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	61	°C/W
Thermal Resistance, Junction to Case		$R_{\theta JC}$	25	
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to 150	°C

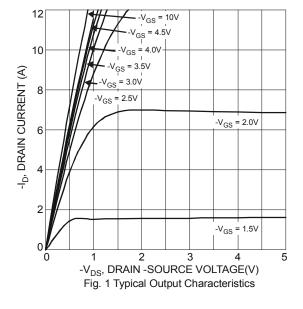
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

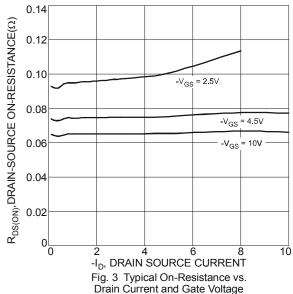
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Body Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±12V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-0.6	_	-1.3	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
			59	77		$V_{GS} = -10V, I_D = -4.2A$
Static Drain-Source On-Resistance	R _{DS (ON)}	_	73	95	mΩ	$V_{GS} = -4.5V, I_D = -4A$
		_	115	150		$V_{GS} = -2.5V, I_D = -3A$
Forward Transconductance	g _{fs}	_	8	_	S	$V_{DS} = -5V, I_{D} = -4A$
Source-Drain Diode Forward Voltage	V_{SD}	_	0.8	-1.25	V	$V_{GS} = 0V, I_S = -3.0A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}		432	864	pF	45)/)/ 0)/
Output Capacitance	Coss		87	174	pF	V _{DS} = -15V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss		62	124	pF	1 - 1:01VII 12
Gate Resistance	R_G	_	4.04	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
SWITCHING CHARACTERISTICS (Note 8)						
Total Gate Charge	Q_G		5.9	11.8	nC	$V_{DS} = -15V$, $V_{GS} = -4.5V$, $I_{D} = -4.0A$
Total Gate Charge	Q G		12	24		$V_{DS} = -15V$, $V_{GS} = -10V$, $I_{D} = -4.0A$
Gate-Source Charge	Q_{GS}		1.0	2.0	IIC	V _{DS} = -15V, V _{GS} = -4.5V, I _D = -4.0A
Gate-Drain Charge	Q_{GD}	_	3.1	6.2		$V_{DS} = -15V$, $V_{GS} = -4.5V$, $I_{D} = -4.0A$
Turn-On Delay Time	t _{d(on)}	_	4.6	9.2	_	
Rise Time	t _r		6.5	13.0		$V_{DS} = -15V, V_{GS} = -10V,$
Turn-Off Delay Time	t _{d(off)} — 27.8		27.8	55.6	ns	$I_D = -1A$, $R_G = 6.0\Omega$
Fall Time	t _f	_	15.0	30.0		

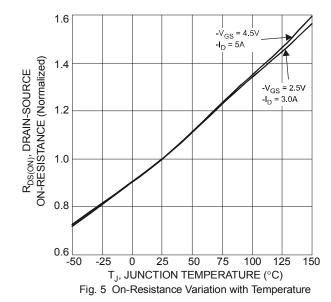
Notes:

- Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing

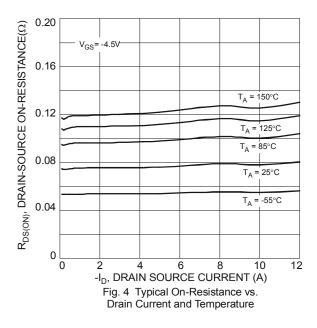








8 V_{DS} = -5.0V -I_D, DRAIN CURRENT (A) T_A = 150°C Γ_A = 125°Ċ = -55°C 0 0 0.5 1.5 2.0 3.0 1.0 2.5 -V_{GS}, GATE-SOURCE VOLTAGE (V) Fig. 2 Typical Transfer Characteristics



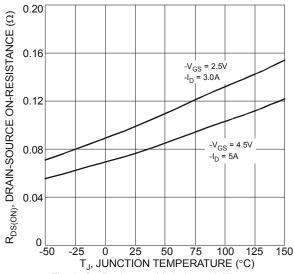


Fig. 6 On-Resistance Variation with Temperature



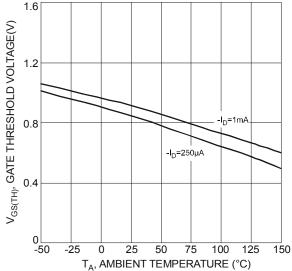
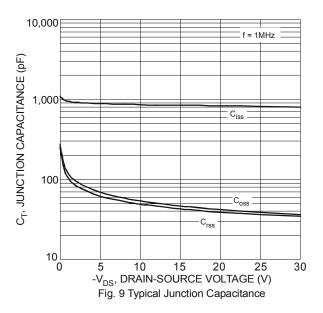
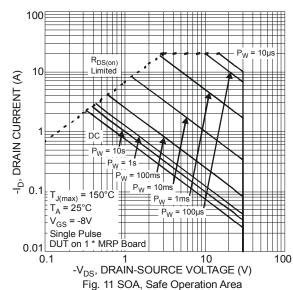
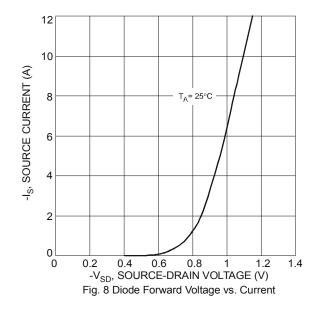
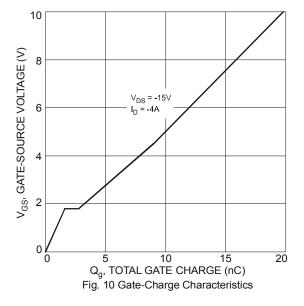


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

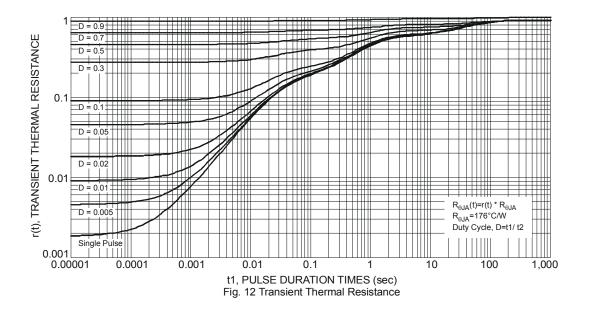






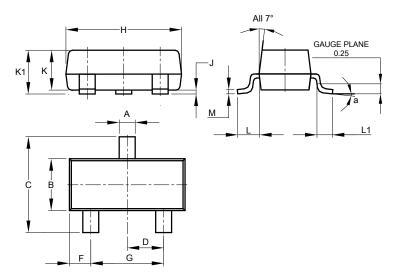






Package Outline Dimensions

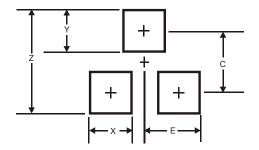
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23								
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
C	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Η	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
М	0.085	0.150	0.110					
α	α 8°							
All	All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
Z	2.9		
Х	0.8		
Υ	0.9		
С	2.0		
E	1.35		



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